



Vincotech

30-EP232PB004ME01-PR09F07T

datasheet

flowDUAL E3BP SiC

2300 V / 4 mΩ

Topology features

- Temperature sensor
- Half Bridge

Component features

- Fast intrinsic diode with low reverse recovery
- High blocking voltage with low on-resistance
- High speed switching with low capacitance

Housing features

- Base isolation: Al₂O₃
- Cu baseplate
- Convex shaped baseplate for superior thermal contact
- CTI600 housing material
- Baseplate with rough surface
- Press-fit pin
- Reliable cold welding connection
- Thermo-mechanical push-and-pull force relief

Target applications

- Charging Stations
- Energy Storage Systems
- General
- Power Supply
- Solar Inverters
- UPS

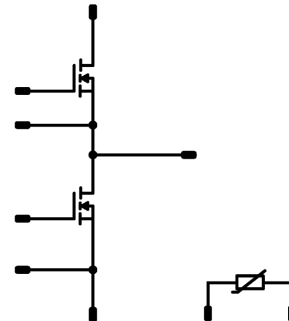
Types

- 30-EP232PB004ME01-PR09F07T

flow E3BP 12 mm housing



Schematic





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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|------------------------------|------------|---------------------------------------|---------|------|
| Half-Bridge Switch | | | | |
| Drain-source voltage | V_{DS} | | 2300 | V |
| Drain current (DC current) | I_D | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 267 | A |
| Peak drain current | I_{DM} | t_p limited by T_{jmax} | 1328 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 749 | W |
| Gate-source voltage | V_{GS} | static | -4 / 15 | V |
| | | dynamic | -8 / 19 | V |
| Maximum Junction Temperature | T_{jmax} | | 175 | °C |

Module Properties

Thermal Properties

| | | | | |
|---|-----------|--|----------------------------|----|
| Storage temperature | T_{stg} | | -40...+125 | °C |
| Operation temperature under switching condition | T_{jop} | | -40...+($T_{jmax} - 25$) | °C |

Isolation Properties

| | | | | |
|----------------------------|------------|-------------------------------------|-------|----|
| Isolation voltage | V_{isol} | DC Test Voltage* $t_p = 2\text{ s}$ | 6800 | V |
| Creepage distance | | | >12,7 | mm |
| Clearance | | | >12,7 | mm |
| Comparative Tracking Index | CTI | | ≥ 600 | |

*100 % tested in production



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Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------|------------------------------|---|-------------------------------------|------------|--------|-----|-----|------|
| | | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | |

Half-Bridge Switch

Static

| | | | | | | | | | | |
|---|--------------|-------------------|-------|------|-------|-----------|-----|---------------|------|----|
| Drain-source on-state resistance ⁽¹⁾ | $r_{DS(on)}$ | | 15 | | 552 | 25 175 | | 3,75 10,88 | 4,88 | mΩ |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$ | | | 0,152 | 25 | 1,8 | 2,5 | 3,6 | V |
| Gate to Source Leakage Current | I_{GSS} | | 15 | 0 | | 25 | | 80 | 800 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | | 0 | 2300 | | 25 | | 8 | 80 | μA |
| Internal gate resistance | r_g | | | | | | | 0,75 | | Ω |
| Gate charge | Q_g | | -4/15 | 1500 | 552 | 25 | | 1176 | | nC |
| Short-circuit input capacitance | C_{iss} | $f = 100$ kHz | 0 | 1500 | 0 | 25 | | 48000 | | pF |
| Short-circuit output capacitance | C_{oss} | | | | | | | 816 | | |
| Reverse transfer capacitance | C_{rss} | | | | | | | 80 | | |
| Diode forward voltage | V_{SD} | | 0 | | 280 | 25 | | 5,5 | | V |

Thermal

| | | | | | | | | | | |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 5,2$ W/mK (PTM) | | | | | | 0,13 | | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|



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Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit | |
|---------------------------------------|----------------------|--|------------------------------|---|-------------------------------------|------------|---------|--------|-----|------|--|
| | | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |
| Dynamic | | | | | | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 4 \ \Omega$ $R_{goff} = 4 \ \Omega$ | -4/15 | 1500 | 336 | 25 | | 122,22 | | ns | |
| | | | | | | 125 | | 111,85 | | | |
| | | | | | | 150 | | 108,38 | | | |
| Rise time | t_r | | | | | 25 | | 68,74 | | ns | |
| | | | | | | 125 | | 60,6 | | | |
| | | | | | | 150 | | 60,67 | | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 | | 537,38 | | ns | |
| | | | | | | 125 | | 574,55 | | | |
| | | | | | | 150 | | 584,02 | | | |
| Fall time | t_f | | | | | 25 | | 36,17 | | ns | |
| | | | | | | 125 | | 38,99 | | | |
| | | | | | | 150 | | 38,12 | | | |
| Turn-on energy (per pulse) | E_{on} | $Q_{tFWD}=1,87 \ \mu C$ $Q_{tFWD}=8,29 \ \mu C$ $Q_{tFWD}=12,35 \ \mu C$ | 25 | | 50,64 | | mWs | | | | |
| | | | 125 | | 51,38 | | | | | | |
| | | | 150 | | 54,84 | | | | | | |
| Turn-off energy (per pulse) | E_{off} | | 25 | | 40,04 | | mWs | | | | |
| | | | 125 | | 39,5 | | | | | | |
| | | | 150 | | 40,16 | | | | | | |
| Peak recovery current | I_{RRM} | $di/dt=6852 \ A/\mu s$ $di/dt=5980 \ A/\mu s$ $di/dt=6421 \ A/\mu s$ | 25 | | 104,41 | | A | | | | |
| | | | 125 | | 121,05 | | | | | | |
| | | | 150 | | 146,6 | | | | | | |
| Reverse recovery time | t_{rr} | | 25 | | 32,33 | | ns | | | | |
| | | | 125 | | 139,66 | | | | | | |
| | | | 150 | | 142,39 | | | | | | |
| Recovered charge | Q_r | | 25 | | 1,87 | | μC | | | | |
| | | | 125 | | 8,29 | | | | | | |
| | | | 150 | | 12,35 | | | | | | |
| Reverse recovered energy | E_{rec} | 25 | | 0,301 | | mWs | | | | | |
| | | 125 | | 5,45 | | | | | | | |
| | | 150 | | 8,39 | | | | | | | |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | 25 | | 10494,76 | | A/ μs | | | | | |
| | | 125 | | 614,45 | | | | | | | |
| | | 150 | | 4041,38 | | | | | | | |



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Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------|------------------------------|---|-------------------------------------|------------|--------|-----|-----|------|
| | | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | |

Thermistor

Static

| | | | | | | | | | | |
|--------------------------------|----------------|------------------------|--|--|--|-----|----|------|---|------|
| Rated resistance | R | | | | | 25 | | 5 | | kΩ |
| Deviation of R100 | $\Delta_{R/R}$ | $R_{100} = 493 \Omega$ | | | | 100 | -5 | | 5 | % |
| Power dissipation | P | | | | | | | 245 | | mW |
| Power dissipation constant | d | | | | | 25 | | 1,4 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. $\pm 2 \%$ | | | | | | 3375 | | K |
| B-value | $B_{(25/100)}$ | Tol. $\pm 2 \%$ | | | | | | 3437 | | K |
| Vincotech Thermistor Reference | | | | | | | | | K | |

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



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Half-Bridge Switch Characteristics

figure 1. MOSFET

Typical output characteristics including $R_{DD'} + R_{SS'}$

$$I_D = f(V_{DS})$$

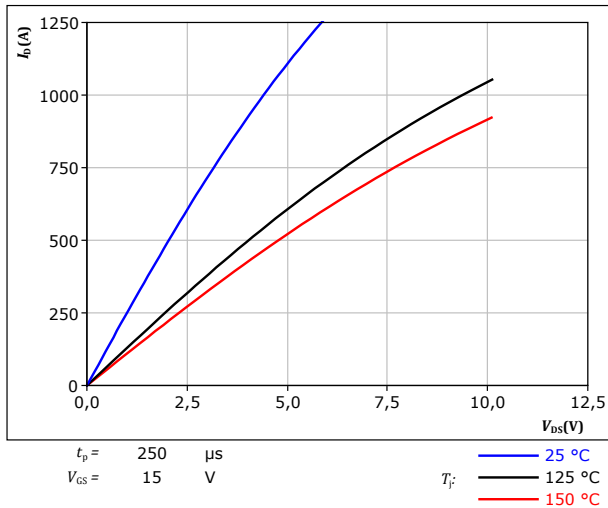


figure 2. MOSFET

Typical output characteristics including $R_{DD'} + R_{SS'}$

$$I_D = f(V_{DS})$$

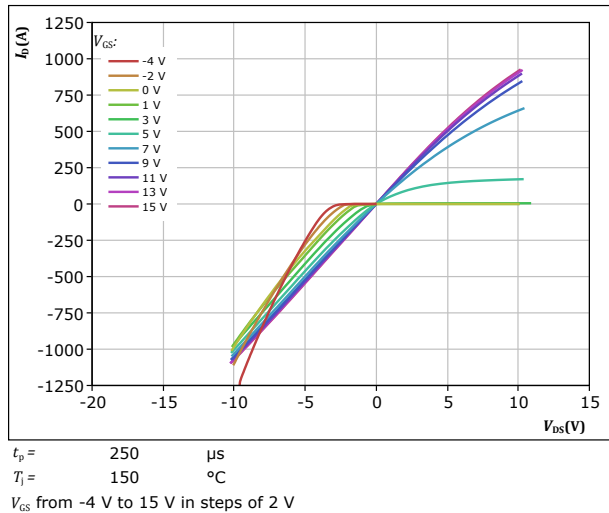


figure 3. MOSFET

Typical transfer characteristics

$$I_D = f(V_{GS})$$

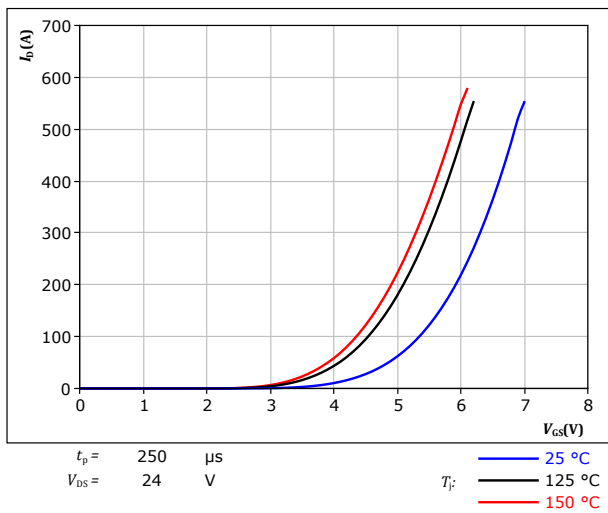
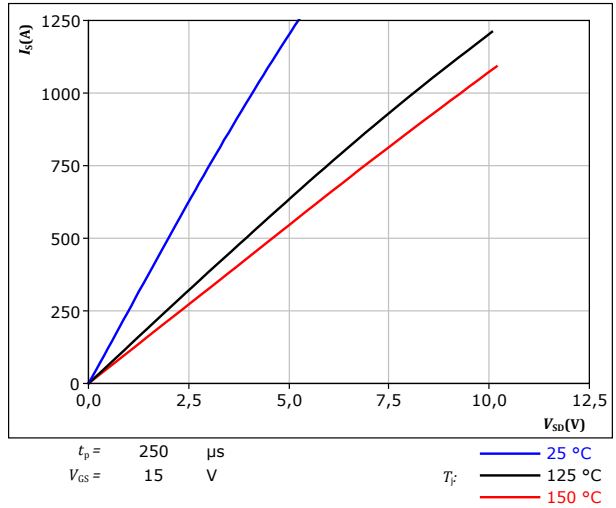


figure 4. MOSFET

Typical reverse drain current characteristics including $R_{DD'} + R_{SS'}$

$$I_{SD} = f(V_{SD})$$





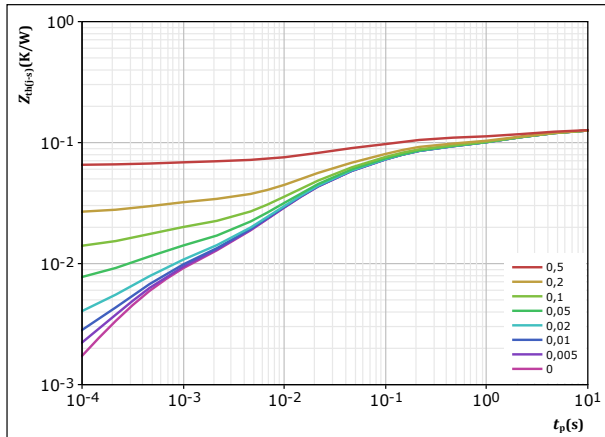
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Half-Bridge Switch Characteristics

figure 5. MOSFET

Transient thermal impedance as a function of pulse width

$$Z_{th(j-a)} = f(t_p)$$



$$D = t_p / T$$

$$R_{th(j-a)} = 0,127 \text{ K/W}$$

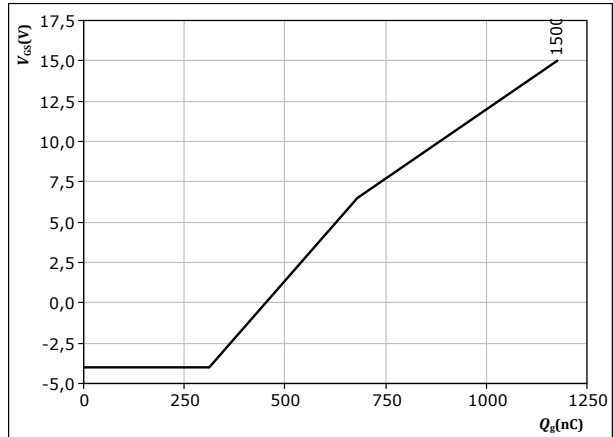
MOSFET thermal model values

| R (K/W) | τ (s) |
|-----------|------------|
| 1,72E-02 | 7,20E+00 |
| 2,79E-02 | 1,50E+00 |
| 4,47E-02 | 8,88E-02 |
| 3,34E-02 | 1,40E-02 |
| 7,06E-03 | 4,39E-04 |

figure 6. MOSFET

Gate voltage vs gate charge

$$V_{GS} = f(Q_g)$$



$$I_D = 400 \text{ A}$$

$$T_j = 25 \text{ } ^\circ\text{C}$$



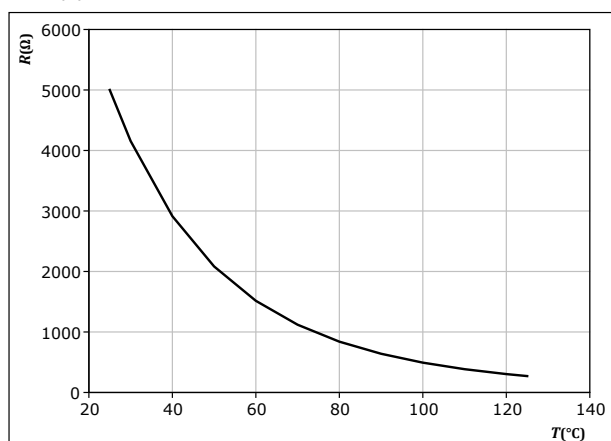
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Thermistor Characteristics

figure 7. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





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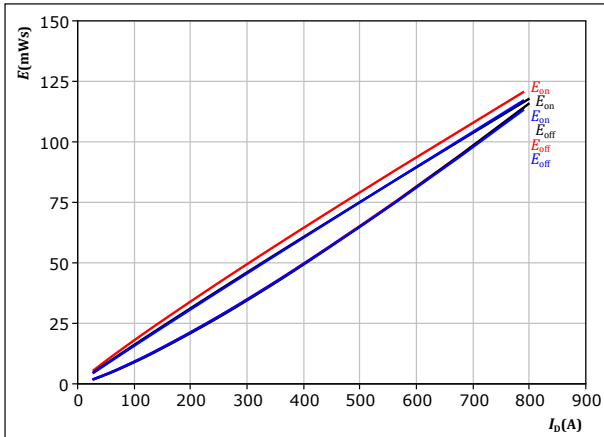
Half-Bridge Switching Characteristics

figure 8.

MOSFET

Typical switching energy losses as a function of drain current

$$E = f(I_D)$$



With an inductive load at

$V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

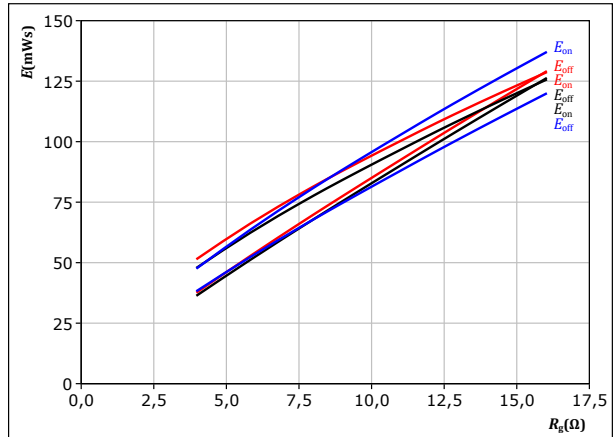
T_j : 25 °C
125 °C
150 °C

figure 9.

MOSFET

Typical switching energy losses as a function of MOSFET turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $I_D = 336$ A

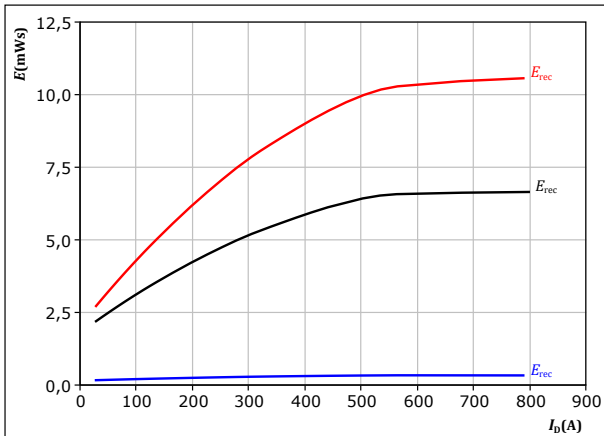
T_j : 25 °C
125 °C
150 °C

figure 10.

MOSFET

Typical reverse recovered energy loss as a function of drain current

$$E_{rec} = f(I_D)$$



With an inductive load at

$V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω

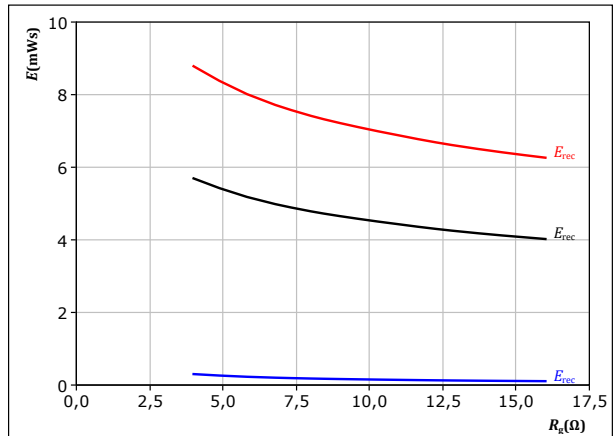
T_j : 25 °C
125 °C
150 °C

figure 11.

MOSFET

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $I_D = 336$ A

T_j : 25 °C
125 °C
150 °C



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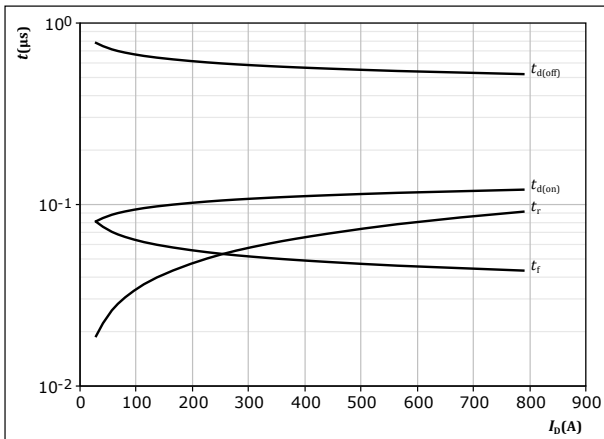
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datasheet

Half-Bridge Switching Characteristics

figure 12.

MOSFET

Typical switching times as a function of drain current
 $t = f(I_D)$



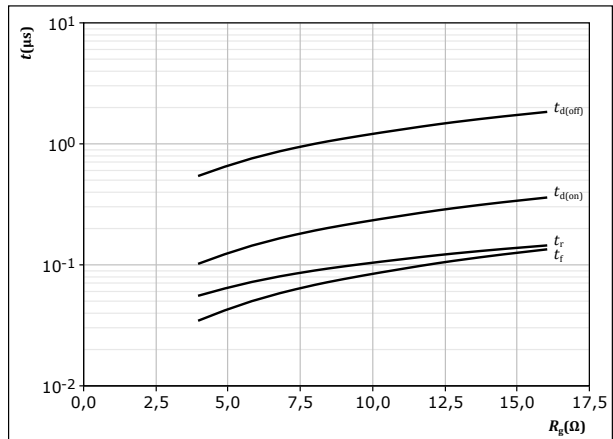
With an inductive load at

$T_j = 150$ °C
 $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 13.

MOSFET

Typical switching times as a function of MOSFET turn on gate resistor
 $t = f(R_g)$



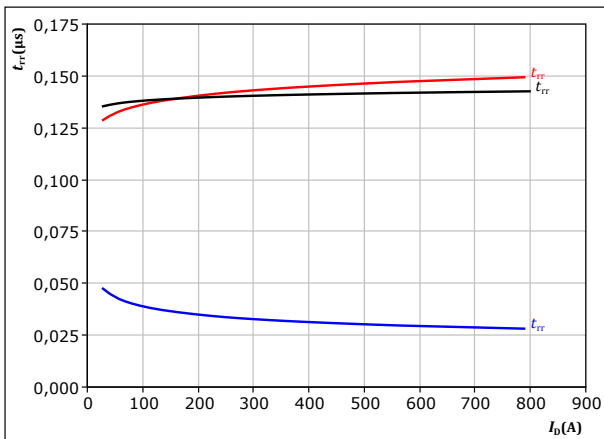
With an inductive load at

$T_j = 150$ °C
 $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $I_D = 336$ A

figure 14.

MOSFET

Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$

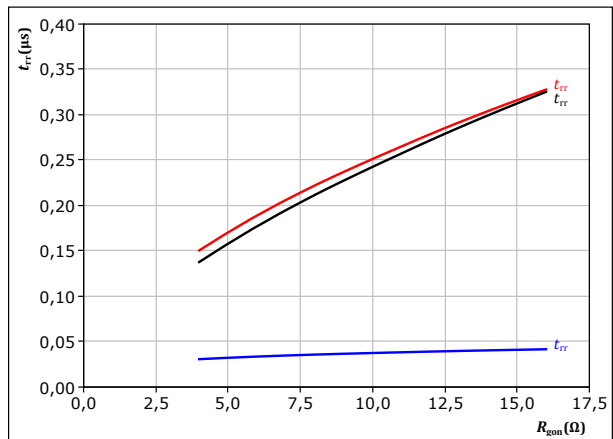


At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $T_j:$ — 25 °C
— 125 °C
— 150 °C

figure 15.

MOSFET

Typical reverse recovery time as a function of MOSFET turn on gate resistor
 $t_{rr} = f(R_{gon})$



At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $I_D = 336$ A
 $T_j:$ — 25 °C
— 125 °C
— 150 °C



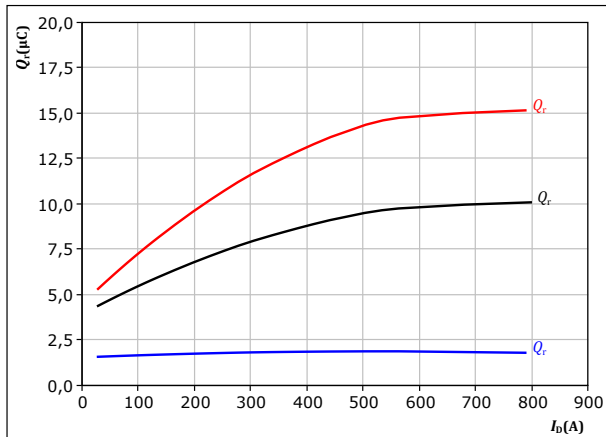
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Half-Bridge Switching Characteristics

figure 16. MOSFET

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$

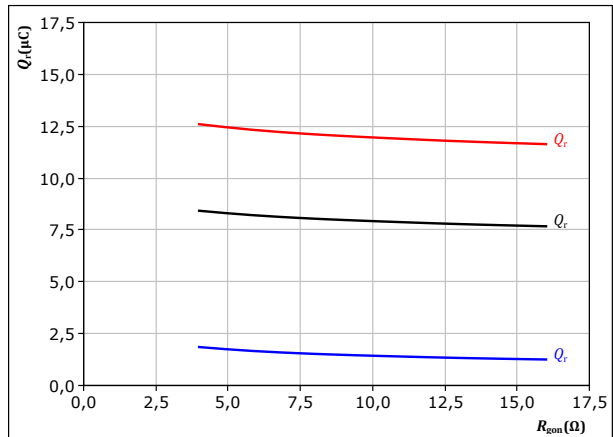


At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C
125 °C
150 °C

figure 17. MOSFET

Typical recovered charge as a function of MOSFET turn on gate resistor

$$Q_r = f(R_{gon})$$

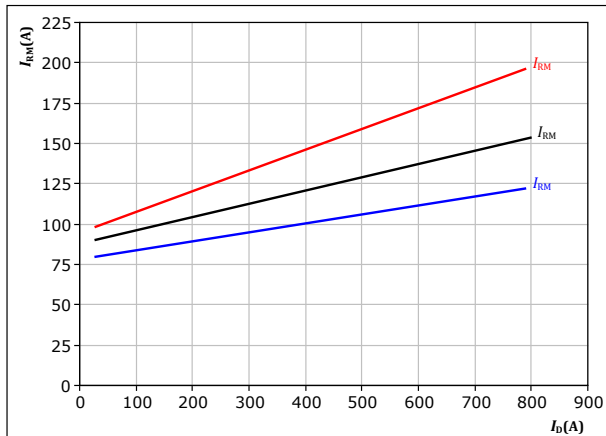


At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $I_D = 336$ A
 T_j : 25 °C
125 °C
150 °C

figure 18. MOSFET

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$

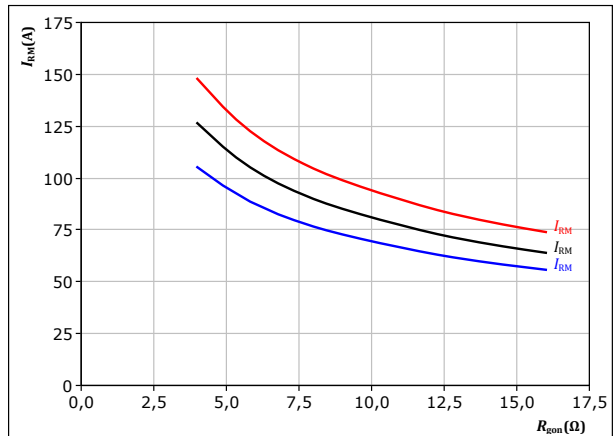


At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 T_j : 25 °C
125 °C
150 °C

figure 19. MOSFET

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $I_D = 336$ A
 T_j : 25 °C
125 °C
150 °C

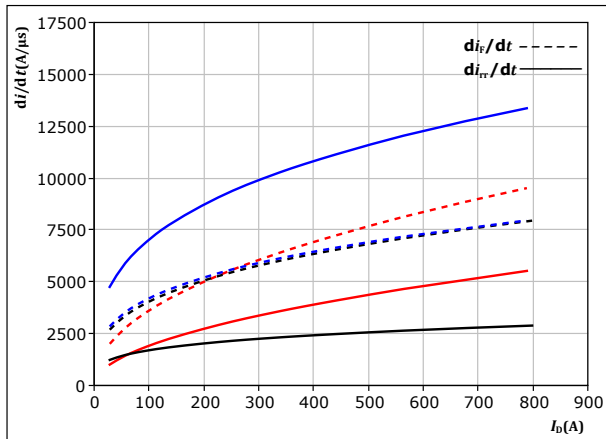


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Half-Bridge Switching Characteristics

figure 20. MOSFET

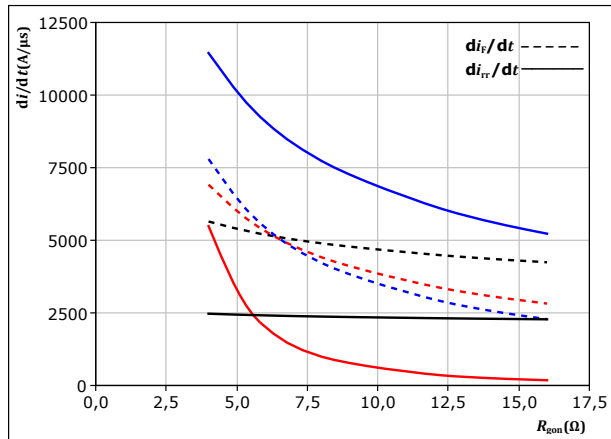
Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_r/dt = f(I_D)$



At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C
 125 °C
 150 °C

figure 21. MOSFET

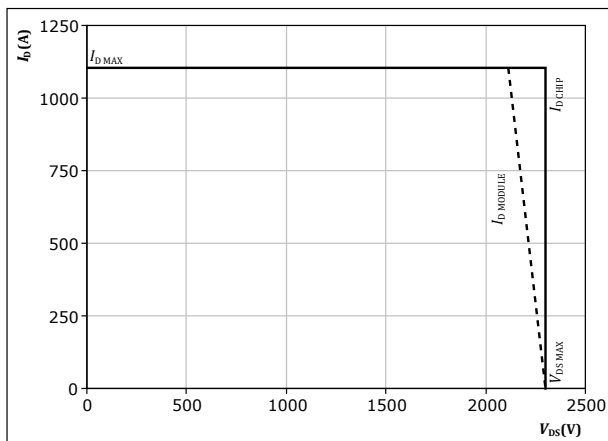
Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_r/dt = f(R_{gon})$



At $V_{DS} = 1500$ V
 $V_{GS} = -4/15$ V
 $I_D = 336$ A
 $T_j = 25$ °C
 125 °C
 150 °C

figure 22. MOSFET

Reverse bias safe operating area
 $I_D = f(V_{DS})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω



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Half-Bridge Switching Definitions

figure 23. MOSFET

Turn-off Switching Waveforms & definition of t_{doff} t_{Eoff} (t_{Eoff} = integrating time for E_{off})



figure 24. MOSFET

Turn-on Switching Waveforms & definition of t_{don} t_{Eon} (t_{Eon} = integrating time for E_{on})



figure 25. MOSFET

Turn-off Switching Waveforms & definition of t_f

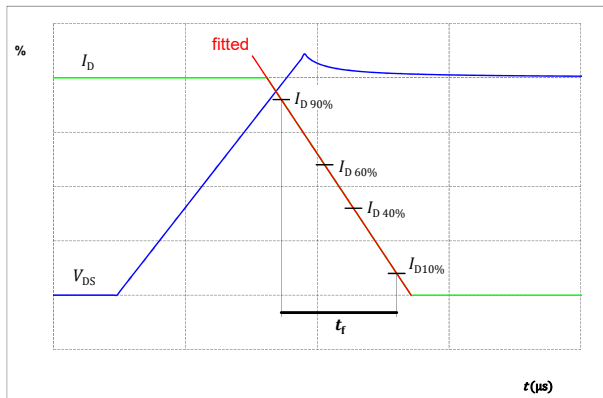
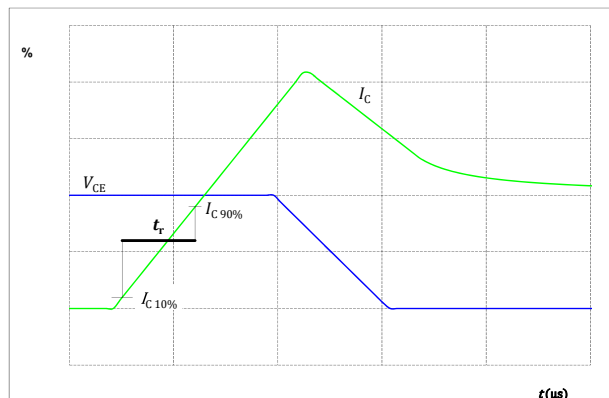


figure 26. MOSFET

Turn-on Switching Waveforms & definition of t_r





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Half-Bridge Switching Definitions

figure 27. FWD

Turn-off Switching Waveforms & definition of t_{tr}

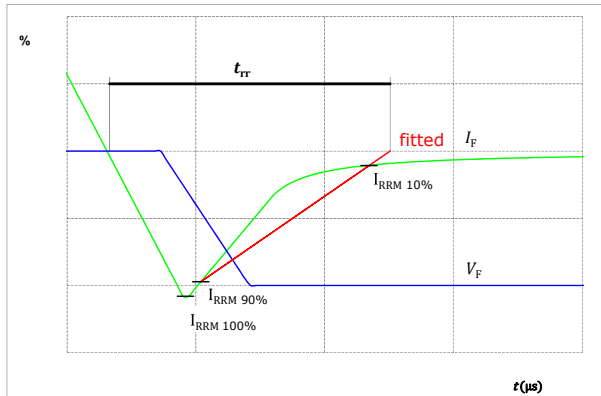


figure 28. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)

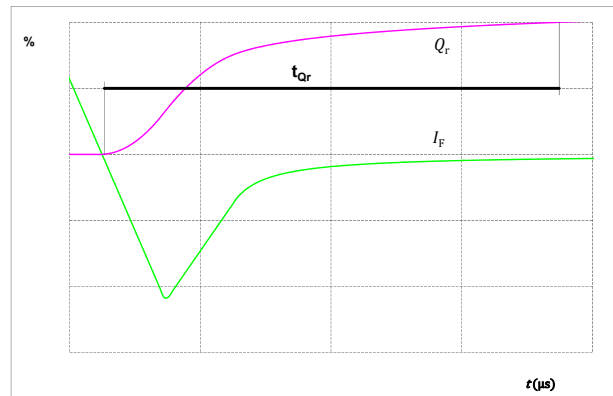
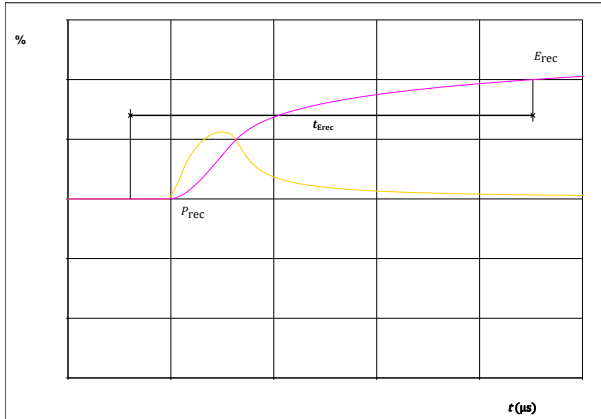


figure 29. FWD

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})





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datasheet

| Ordering Code | |
|--|--------------------------------|
| Version | Ordering Code |
| Without thermal paste | 30-EP232PB004ME01-PR09F07T |
| With thermal paste (5,2 W/mK, PTM6000HV) | 30-EP232PB004ME01-PR09F07T-/7/ |

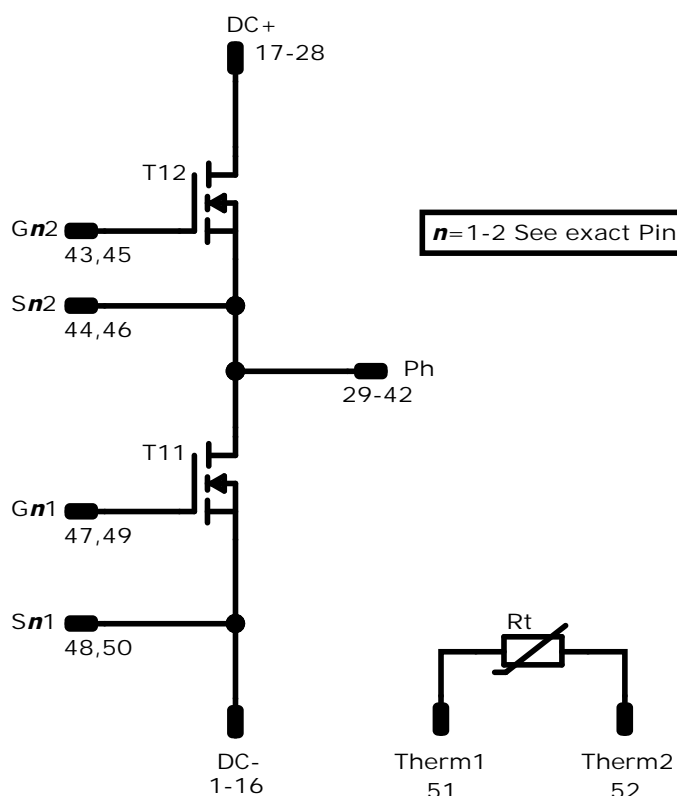
| Marking | | | | | | |
|---------|------------|-------------------------------|------------|----------|-----------|--------|
| | Text | Name | Date code | UL & VIN | Lot | Serial |
| | | NN-NNNNNNNNNNNNNN- TTTTTVV | WWYY | UL VIN | LLLLL | SSSS |
| | Datamatrix | Type&Ver | Lot number | Serial | Date code | |
| | | TTTTTVV | LLLLL | SSSS | WWYY | |

| Outline | | | | | | | | |
|----------------|-------|------|----------|----|-------|------|--------|--|
| Pin table [mm] | | | | | | | | |
| Pin | X | Y | Function | 27 | 68,96 | 48 | DC+ | |
| 1 | 28,8 | 0 | DC- | 28 | 72,16 | 48 | DC+ | |
| 2 | 32 | 0 | DC- | 29 | 0 | 6,4 | Ph | |
| 3 | 28,8 | 3,2 | DC- | 30 | 3,2 | 6,4 | Ph | |
| 4 | 32 | 3,2 | DC- | 31 | 0 | 9,6 | Ph | |
| 5 | 28,8 | 19,2 | DC- | 32 | 3,2 | 9,6 | Ph | |
| 6 | 32 | 19,2 | DC- | 33 | 0 | 12,8 | Ph | |
| 7 | 28,8 | 22,4 | DC- | 34 | 3,2 | 12,8 | Ph | |
| 8 | 32 | 22,4 | DC- | 35 | 3,2 | 16 | Ph | |
| 9 | 28,8 | 25,6 | DC- | 36 | 3,2 | 32 | Ph | |
| 10 | 32 | 25,6 | DC- | 37 | 0 | 35,2 | Ph | |
| 11 | 28,8 | 28,8 | DC- | 38 | 3,2 | 35,2 | Ph | |
| 12 | 32 | 28,8 | DC- | 39 | 0 | 38,4 | Ph | |
| 13 | 28,8 | 44,8 | DC- | 40 | 3,2 | 38,4 | Ph | |
| 14 | 32 | 44,8 | DC- | 41 | 0 | 41,6 | Ph | |
| 15 | 28,8 | 48 | DC- | 42 | 3,2 | 41,6 | Ph | |
| 16 | 32 | 48 | DC- | 43 | 43,36 | 44,8 | G12 | |
| 17 | 68,96 | 0 | DC+ | 44 | 43,36 | 48 | S12 | |
| 18 | 72,16 | 0 | DC+ | 45 | 43,36 | 3,2 | G22 | |
| 19 | 68,96 | 3,2 | DC+ | 46 | 43,36 | 0 | S22 | |
| 20 | 72,16 | 3,2 | DC+ | 47 | 25,6 | 44,8 | G11 | |
| 21 | 68,96 | 6,4 | DC+ | 48 | 25,6 | 48 | S11 | |
| 22 | 72,16 | 6,4 | DC+ | 49 | 25,6 | 3,2 | G21 | |
| 23 | 68,96 | 41,6 | DC+ | 50 | 25,6 | 0 | S21 | |
| 24 | 72,16 | 41,6 | DC+ | 51 | 0 | 0 | Therm1 | |
| 25 | 68,96 | 44,8 | DC+ | 52 | 3,2 | 0 | Therm2 | |
| 26 | 72,16 | 44,8 | DC+ | | | | | |



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Pinout




Identification

| ID | Component | Voltage | Current | Function | Comment |
|----------|------------|---------|---------|--------------------|---|
| T11, T12 | MOSFET | 2300 V | 3,75 mΩ | Half-Bridge Switch | Parallel devices with separate control. Values apply to complete device. |
| Rt | Thermistor | | | Thermistor | |



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30-EP232PB004ME01-PR09F07T
datasheet

| Packaging instruction | | | | |
|---|------|----------|------|---|
| Standard packaging quantity (SPQ) 24 | >SPQ | Standard | <SPQ | Sample |
| Handling instruction | | | | |
| Handling instructions for <i>flow</i> E3BP packages see vincotech.com website. | | | | |
| Package data | | | | |
| Package data for <i>flow</i> E3BP packages see vincotech.com website. | | | | |
| Vincotech thermistor reference | | | | |
| See Vincotech thermistor reference table at vincotech.com website. | | | | |
| UL recognition and file number | | | | |
| This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,op}=175^{\circ}\text{C}$ and up to 4000VAC/1min isolation voltage. For more information see vincotech.com website. | | | |  |

| Document No.: | Date: | Modification: | Pages |
|----------------------------------|--------------|---------------------------|-------|
| 30-EP232PB004ME01-PR09F07T-D1-14 | 17 Oct. 2025 | Initial Release | |
| 30-EP232PB004ME01-PR09F07T-D2-14 | 18 May. 2026 | Change Half-Bridge Switch | |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.